



Solder Preforms for PCB Assembly

ALPHA Exactalloy® Tape and Reel Preforms



macdermidalpha.com March, 2022

INCREASE SOLDER VOLUME

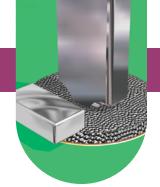
With electrical components sizes becoming ever smaller, printing sufficient amounts of solder paste onto miniaturized, overpopulated PCBs has become increasingly challenging.

ALPHA Exactalloy Tape and Reel Preforms are specifically designed to overcome these solder volume deficiencies, enhancing the solder joint strength and reliability and providing 100% hole fill.

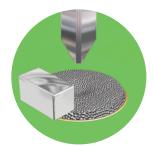
ALPHA Exactalloy Preforms in tape and reel packaging provide an easy to implement method for increasing the solder volume of SMT and through-hole components assembled using surface mount technology.

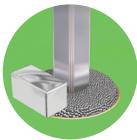
Specifically targeted for use with solder paste in SMT assembly applications, small solder rectangles are inserted into solder paste to precisely increase solder volume, the solder paste acting as both an adhesive and flux vehicle. The solder rectangles are 100% alloy, and due to the minimal amount of solder paste required to provide adequate wetting, near zero flux residue is realized.

The entire family of solder rectangles in tape and reel packaging are placed with standard pick and place equipment, utilizing industry standard chip capacitor size preforms for ease of use.



Supplemented with ALPHA Exactalloy Preforms







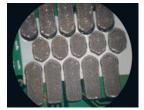
A preform added to solder paste yields 100% hole fill plus fillet.

Add a preform to an SMT component lead to increase joint strength.

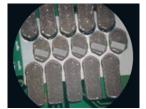


Click here to watch preform reflow video.

Restricted Printing Area



Solder paste as printed



Preforms placed in paste



Solder paste and preforms reflowed



ALPHA Exactalloy Tape and Reel Preforms enable the use of standard pick and place equipment.



Preforms provide additional solder for tight pitch components and thick PCBs ensuring 100% hole fill and fillet formation.

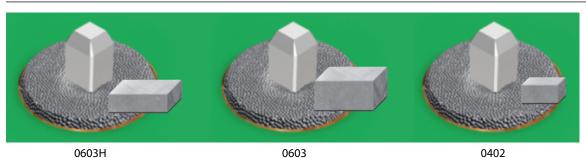
INCREASE SOLDER VOLUME

Alpha Exactalloy Tape and Reel Preforms provide customers with:

- · Increased solder joint reliability
- Improved first pass yields
- 100% hole fill
- Increased solder volume without the need for PCB layout changes or use of step stencils
- A significant time-to-market advantage with the use of tape and reel packaging

ALPHA Exactalloy Preforms are available in a wide variety of solder alloys, including low temperature, RoHS compliant alloys, such as SnBiAg and the Innolot alloy for extra joint strength.





Different chip cap. size solder preforms applied before reflow



Desired result after reflow, the 0603 chip cap. size creating the largest fillet

Size		Dimensions			Walana a	Dimensions			Walama.	ee ee	_ م	Temp free
31	ze	a	b	С	Volume	a	b	С	Volume	Pb-Free	Sn-Pb	v Tem b-free
inch	mm		mm		mm³		mil		mil ³	_ ₹	V)	Low Pb-
0201H	0503H	0.51	0.25	0.10	0.013	20	10	4	800	~	*	*
0201	0503	0.47	0.28	0.28	0.037	19	11	11	2,249	<u></u>	1	/
0202	0505	0.51	0.51	0.25	0.065	20	20	10	3,968	1	1	~
0402H	1006H	1.00	0.60	0.25	0.150	39	24	10	9,154	<u>~</u>	1	/
0402	1005	1.00	0.50	0.50	0.250	39	20	20	15,256	1	1	~
0603H	1608H	1.60	0.80	0.50	0.640	63	31	20	39,055	1	1	~
0603	1608	1.60	0.80	0.80	1.024	63	31	31	62,488	1	1	1
0805H	2013H	2.01	1.30	0.40	1.045	79	51	16	63,782	1	1	/
0805	2013	2.01	1.30	0.76	1.986	79	51	30	121,186	1	1	1
0805S	20135	2.01	1.30	1.30	3.397	79	51	51	207,292	~	1	*
1406	3515	3.56	1.52	0.77	4.167	140	60	30	254,263	~	1	*

^{*}Production will depend on market demand. Please check with your local sales representative for availability.

ALPHA Solder Preforms for PCB Assembly

ALPHA Exactalloy solder preforms are available in a wide range of leaded and lead-free alloys to meet the most challenging assembly requirements.

Leaded Exactalloy		ting Range	Remarks		
Alloy Name	°C °F				
Sn62 Pb36 Ag2	179	354	Silver containing eutectic alloy		
Sn63 Pb37	183	361	Most popular leaded eutectic alloy		
Sn60 Pb40	183-188	361-370	Off-eutectic, silver free alloy		
In50 Pb50	184-209	363-408	High ductility alloy		
Low Temp Leaded Exactalloy	Melting Temp Range		Remarks		
Alloy Name	°C	°F			
Sn16 Pb32 Bi52	95-96	203-205	Ultra low temperature, cadmium free		
Sn25 Pb25 Bi50	95-115	203-239	Low temperature, cadmium free		
High Temp Leaded Exactalloy		ting Range	Remarks		
Alloy Name	°C	°F			
Sn10 Pb88 Ag2	268-290	514-554			
Sn5 Pb92.5 Ag2.5	280	536	Most popular high leaded, high temperature alloys		
Sn2 Pb95.5 Ag2.5	299-304	570-579			
In5 Pb92.5 Ag2.5	300	572			
Sn5 Pb95	310-314	590-597			

RoHS Compliant Exactalloy		ting Range	Remarks	
Alloy Name	°C	°F		
SAC305*	217-221	422-430	Most popular RoHS compliant alloy	
SACX	217-228	422-442	Low silver (Ag0.3) SAC alloy	
Sn96.5 Ag3.5	221	430	Eutectic, copper free	
SN96 Ag4	221-238	430-460	Off-eutectic, copper free	
Sn99 Sb1	235	455	Eutectic, Sb containing alloy	
Sn95 Sb5	232-240	450-464	Off-eutectic, Sb containing alloy	
Low Temp RoHS Compliant Exactalloy	Melting Temp Range		Remarks	
		italige	Remarks	
Alloy Name	°C	°F	Kemarks	
			Eutectic, RoHS compliant alloy	
Alloy Name	°C	°F		
Alloy Name Sn42 Bi58	°C 138 138-139	°F 280	Eutectic, RoHS compliant alloy	
Alloy Name Sn42 Bi58 Sn42 Bi57.6 Ag0.4	°C 138 138-139	°F 280 280-282 280-338	Eutectic, RoHS compliant alloy Silver added for ductility	
Alloy Name Sn42 Bi58 Sn42 Bi57.6 Ag0.4 Sn60 Bi39.6 Ag0.4	°C 138 138-139 138-170	°F 280 280-282 280-338	Eutectic, RoHS compliant alloy Silver added for ductility Off-eutectic, low temperature RoHS alloy	
Alloy Name Sn42 Bi58 Sn42 Bi57.6 Ag0.4 Sn60 Bi39.6 Ag0.4 Sn52 In48	°C 138 138-139 138-170 118-131 118	°F 280 280-282 280-338 244-268	Eutectic, RoHS compliant alloy Silver added for ductility Off-eutectic, low temperature RoHS alloy Ultra low temperature, off eutectic alloy	
Alloy Name Sn42 Bi58 Sn42 Bi57.6 Ag0.4 Sn60 Bi39.6 Ag0.4 Sn52 In48 Sn48 In52 High Reliability RoHS	°C 138 138-139 138-170 118-131 118	°F 280 280-282 280-338 244-268 244 ting	Eutectic, RoHS compliant alloy Silver added for ductility Off-eutectic, low temperature RoHS alloy Ultra low temperature, off eutectic alloy Ultra low temperature, eutectic alloy	

^{*}Various other SAC alloy variants can be made available, including SAC105, SAC387 and SAC405

For available preform shapes, alloys, sizes and flux options, please refer to the corresponding Technical Bulletin or contact your local Kester Distributor.

Sustainability 🛭

All ALPHA Exactalloy Solder Preforms are produced in an ISO 14001 & 45001 qualified production environment. This certification ensures strict adherence to environmental management systems with a strong focus on health and safety. All metal waste resulting from our manufacturing processes is recycled.

ALPHA Exactalloy Solder Preforms are manufactured in TS16949 certified production sites.

During assembly processes, solder preforms support the use of alternative soldering methods like induction, laser or light beam soldering, using short bursts of energy rather than prolonged energy consumption associated with traditional soldering methods. ALPHA Exactalloy Solder Preforms are available in a range of low temperature, RoHS compliant alloys, enabling the most energy efficient soldering solutions.



Kester.com March 2022



For more information, contact us at Assembly@MacDermidAlpha.com

Alpha and Kester are product brands of MacDermid Alpha Electronics Solutions.

^{**}Above listed alloys are the most commonly used types in our industries. Please consult us about the availability of other alloys.

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